



- **Infrared reflow oven RK180**
- max. PCB size 180 x 120 mm
- max. temp. 250°C



- **Infrared reflow oven RK300**
- max. PCB size 250 x 350 mm
- max. temp. 250°C



- **Hot air / infrared reflow oven RK320**
- max. PCB size 300 x 200 mm
- Lead free soldering



- **Hot air / infra red reflow oven RK360**
- max. PCB size 330 x 220 mm
- Lead free soldering



- **convection conveyor reflow oven R260**
- length of the process chamber - 860mm
- max. PCB width 260 mm
- lead free soldering



- **convection conveyor reflow oven R360**
- length of the process chamber - 1400mm
- max. PCB width 360 mm
- lead free soldering



- **convection conveyor reflow oven R460**
- length of process chamber - 2400mm
- max. PCB width 460 mm
- Lead free soldering